BFG540; BFG540/X; BFG540/XR

NPN 9 GHz wideband transistor

Rev. 05 — 21 November 2007

Product data sheet

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NXP Semiconductors



BFG540/XR

NPN 9 GHz wideband transistor

FEATURES

- High power gain
- Low noise figure
- High transition frequency
- Gold metallization ensures excellent reliability.

DESCRIPTION

NPN silicon planar epitaxial transistors, intended for wideband applications in the GHz range, such as analog and digital cellular telephones, cordless telephones (CT1, CT2, DECT, etc.), radar detectors, satellite TV tuners (SATV), MATV/CATV amplifiers and repeater amplifiers in fibre-optical systems.

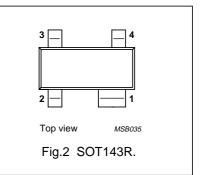
The transistors are mounted in plastic SOT143B and SOT143R packages.

PINNING

PIN	DESCRIPTION			
BFG540 (F	ig.1) Code: %MG			
1	collector			
2	base			
3	emitter			
4	emitter			
BFG540/X	(Fig.1) Code: %MM			
1	collector			
2	emitter			
3	base			
4	emitter			
BFG540/XR (Fig.2) Code: %MR				
1	collector			
2	emitter			
3	base			
4	emitter			

4 3 3 1 2 Top view MSB014 Fig.1 SOT143B.

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QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter	-	-	20	V
V _{CES}	collector-emitter voltage	R _{BE} = 0	-	-	15	V
I _C	DC collector current		-	-	120	mA
P _{tot}	total power dissipation	$T_s \le 60 \ ^{\circ}C$; note 1	_	-	400	mW
h _{FE}	DC current gain	$I_{C} = 40 \text{ mA}; V_{CE} = 8 \text{ V}; T_{j} = 25 \text{ °C}$	100	120	250	
C _{re}	feedback capacitance	$I_{C} = 0; V_{CE} = 8 V; f = 1 MHz$	—	0.5	-	pF
f _T	transition frequency	I_{C} = 40 mA; V_{CE} = 8 V; f = 1 GHz; T_{amb} = 25 °C	-	9	-	GHz
G _{UM}	maximum unilateral power gain	$I_{C} = 40 \text{ mA}; V_{CE} = 8 \text{ V}; f = 900 \text{ MHz};$ $T_{amb} = 25 \text{ °C}$	-	18	-	dB
		I _C = 40 mA; V _{CE} = 8 V; f = 2 GHz; T _{amb} = 25 °C	-	11	-	dB
s ₂₁ ²	insertion power gain	I_{C} = 40 mA; V _{CE} = 8 V; f = 900 MHz; T _{amb} = 25 °C	15	16	-	dB
F	noise figure	$\Gamma_{s} = \Gamma_{opt}$; I _C = 10 mA; V _{CE} = 8 V; f = 900 MHz; T _{amb} = 25 °C	-	1.3	1.8	dB
		$ \Gamma_{s} = \Gamma_{opt}; \ I_{C} = 40 \text{ mA}; \ V_{CE} = 8 \text{ V}; $	-	1.9	2.4	dB
		$\Gamma_{s} = \Gamma_{opt}$; I _C = 10 mA; V _{CE} = 8 V; f = 2 GHz; T _{amb} = 25 °C	-	2.1	_	dB

LIMITING VALUES

In accordance with the Absolute Maximum System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter	_	20	V
V _{CES}	collector-emitter voltage	$R_{BE} = 0$	_	15	V
V _{EBO}	emitter-base voltage	open collector	_	2.5	V
I _C	DC collector current		_	120	mA
P _{tot}	total power dissipation	$T_s \le 60 \text{ °C}; \text{ note } 1$	_	400	mW
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		_	150	°C

Note

1. T_s is the temperature at the soldering point of the collector pin.

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th j-s}	thermal resistance from junction to soldering point	$T_s \le 60 \ ^{\circ}C$; note 1	290	K/W

Note

1. T_s is the temperature at the soldering point of the collector pin.

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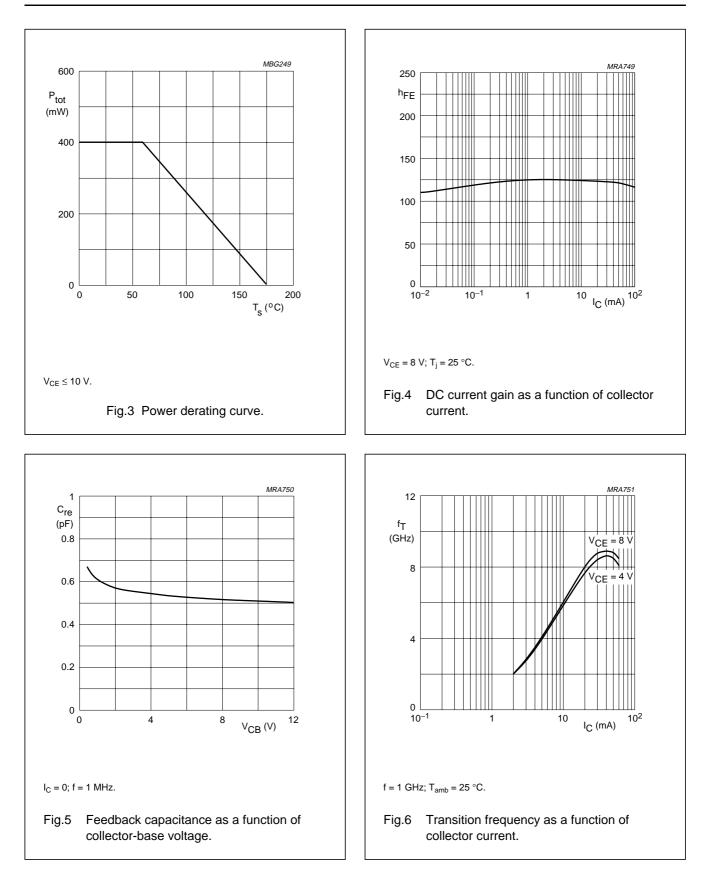
CHARACTERISTICS

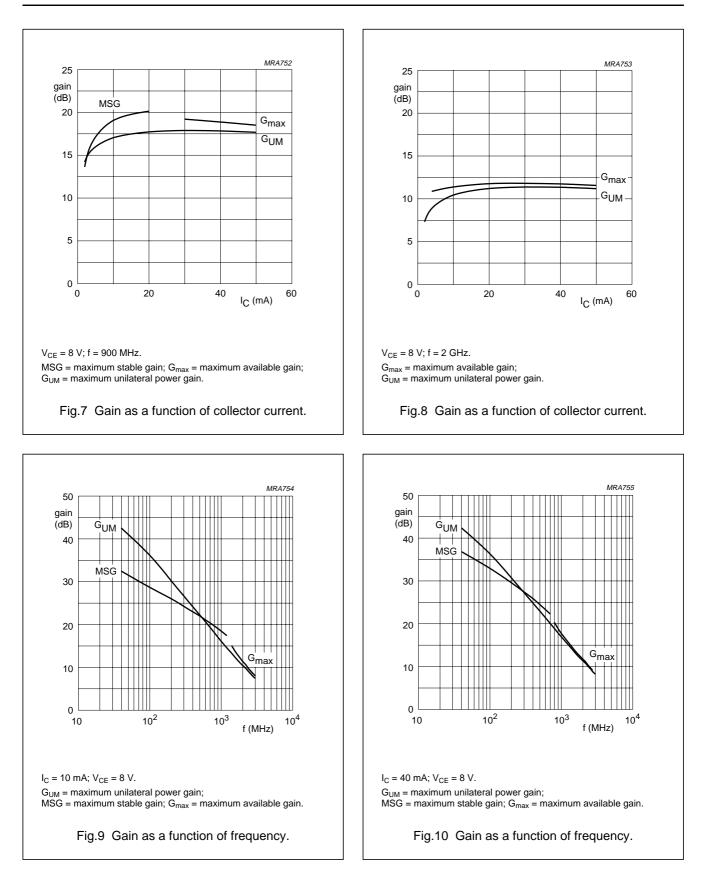
T_i = 25 °C unless otherwise specified.

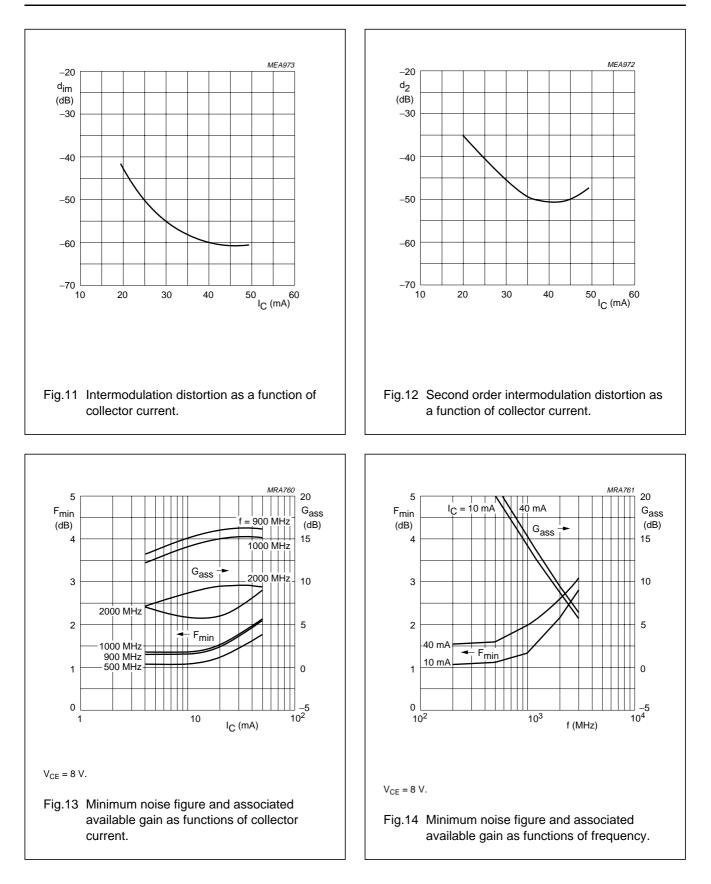
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I _{CBO}	collector cut-off current	I _E = 0; V _{CB} = 8 V	-	-	50	nA
h _{FE}	DC current gain	I _C = 40 mA; V _{CE} = 8 V	60	120	250	
C _e	emitter capacitance	$I_{C} = i_{c} = 0; V_{EB} = 0.5 V; f = 1 MHz$	-	2	-	pF
C _c	collector capacitance	I _E = i _e = 0; V _{CB} = 8 V; f = 1 MHz	-	0.9	-	pF
C _{re}	feedback capacitance	I _C = 0; V _{CB} = 8 V; f = 1 MHz	-	0.5	-	pF
f _T	transition frequency	I_{C} = 40 mA; V_{CE} = 8 V; f = 1 GHz; T _{amb} = 25 °C	-	9	-	GHz
G _{UM}	maximum unilateral power gain (note 1)	I_{C} = 40 mA; V _{CE} = 8 V; f = 900 MHz; T _{amb} = 25 °C	-	18	-	dB
		$I_C = 40 \text{ mA}; V_{CE} = 8 \text{ V}; f = 2 \text{ GHz};$ $T_{amb} = 25 \text{ °C}$	-	11	-	dB
s ₂₁ ²	insertion power gain	I_{C} = 40 mA; V _{CE} = 8 V; f = 900 MHz; T _{amb} = 25 °C	15	16	-	dB
F	noise figure	$\Gamma_{s} = \Gamma_{opt}$; I _C = 10 mA; V _{CE} = 8 V; f = 900 MHz; T _{amb} = 25 °C	-	1.3	1.8	dB
		$\Gamma_{s} = \Gamma_{opt}$; I _C = 40 mA; V _{CE} = 8 V; f = 900 MHz; T _{amb} = 25 °C	-	1.9	2.4	dB
		$\Gamma_{s} = \Gamma_{opt}$; I _C = 10 mA; V _{CE} = 8 V; f = 2 GHz; T _{amb} = 25 °C	-	2.1	-	dB
P _{L1}	output power at 1 dB gain compression	I_C = 40 mA; V _{CE} = 8 V; R _L = 50 Ω; f = 900 MHz; T _{amb} = 25 °C	-	21	-	dBm
ITO	third order intercept point	note 2	-	34	-	dBm
Vo	output voltage	note 3	-	500	-	mV
d ₂	second order intermodulation distortion	note 4	-	-50	-	dB

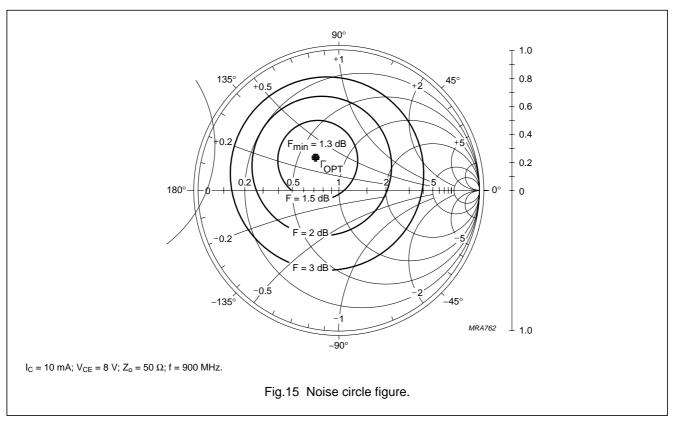
Notes

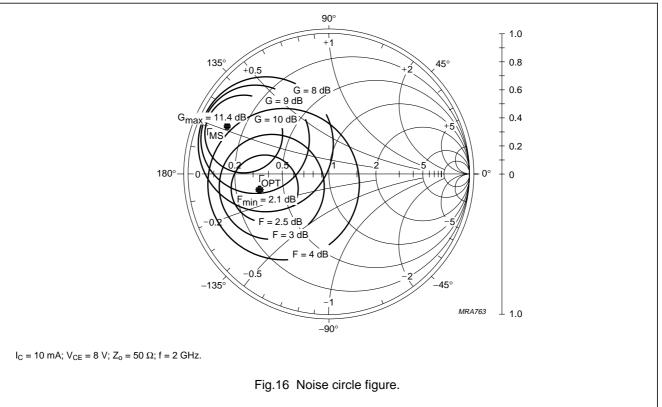
- 1. G_{UM} is the maximum unilateral power gain, assuming s_{12} is zero and $G_{UM} = 10 \log \frac{|s_{21}|^2}{(1-|s_{11}|^2)(1-|s_{22}|^2)} dB$.
- 2. $V_{CE} = 8 \text{ V}; I_{C} = 40 \text{ mA}; R_{L} = 50 \Omega; T_{amb} = 25 \text{ °C};$ $f_{p} = 900 \text{ MHz}; f_{q} = 902 \text{ MHz};$ measured at $f_{(2p-q)} = 898 \text{ MHz}$ and $f_{(2q-p)} = 904 \text{ MHz}.$
- 3. $d_{im} = -60 \text{ dB} \text{ (DIN 45004B)}; I_C = 40 \text{ mA}; V_{CE} = 8 \text{ V}; Z_L = Z_S = 75 \Omega; T_{amb} = 25 °C;$ $V_p = V_O; V_q = V_O - 6 \text{ dB}; V_r = V_O - 6 \text{ dB};$ $f_p = 795.25 \text{ MHz}; f_q = 803.25 \text{ MHz}; f_r = 805.25 \text{ MHz};$ measured at $f_{(p + q - r)} = 793.25 \text{ MHz}.$
- 4. $I_{C} = 40 \text{ mA}; V_{CE} = 8 \text{ V}; V_{O} = 275 \text{ mV}; T_{amb} = 25 \text{ °C};$ $f_{p} = 250 \text{ MHz}; f_{q} = 560 \text{ MHz};$ measured at $f_{(p+q)} = 810 \text{ MHz}.$

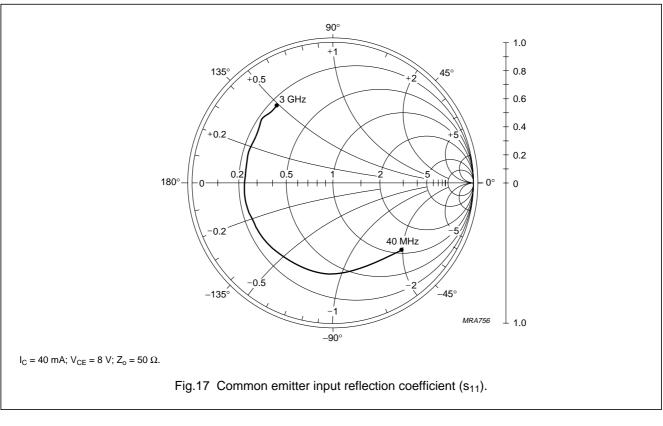


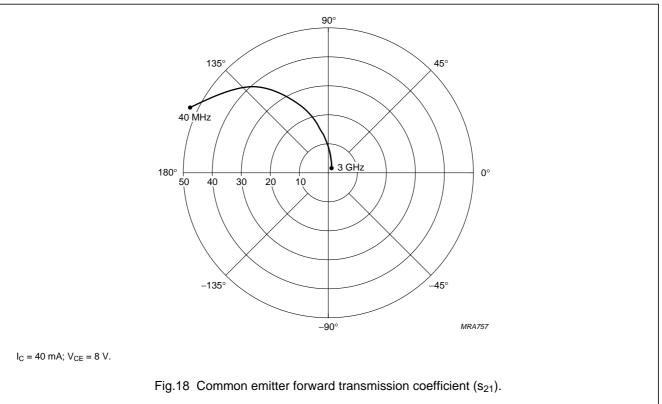


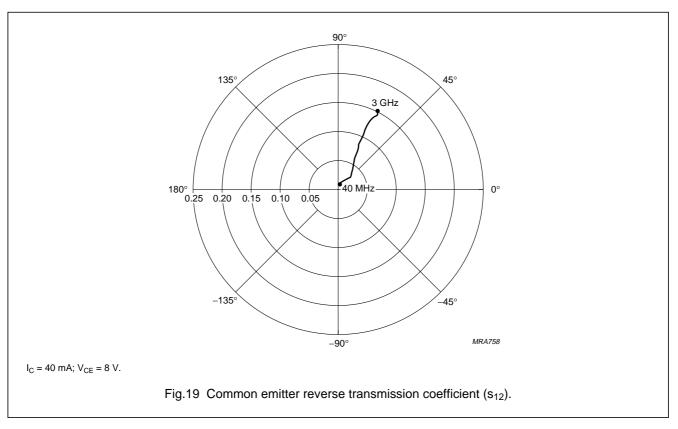


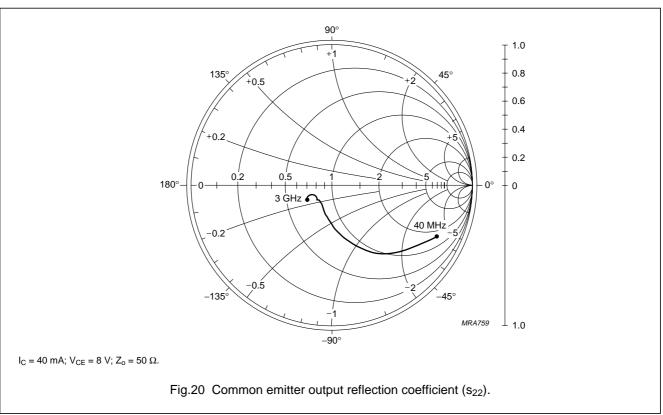












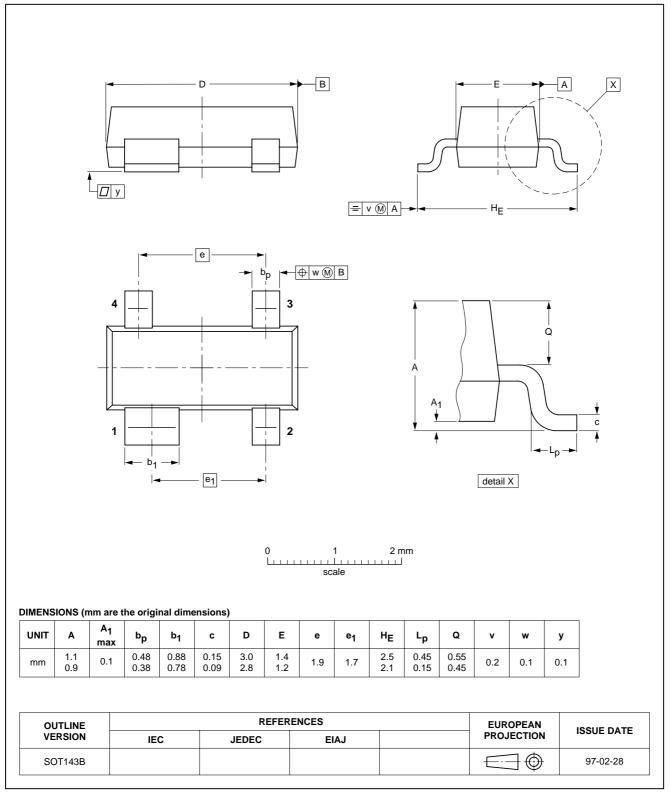
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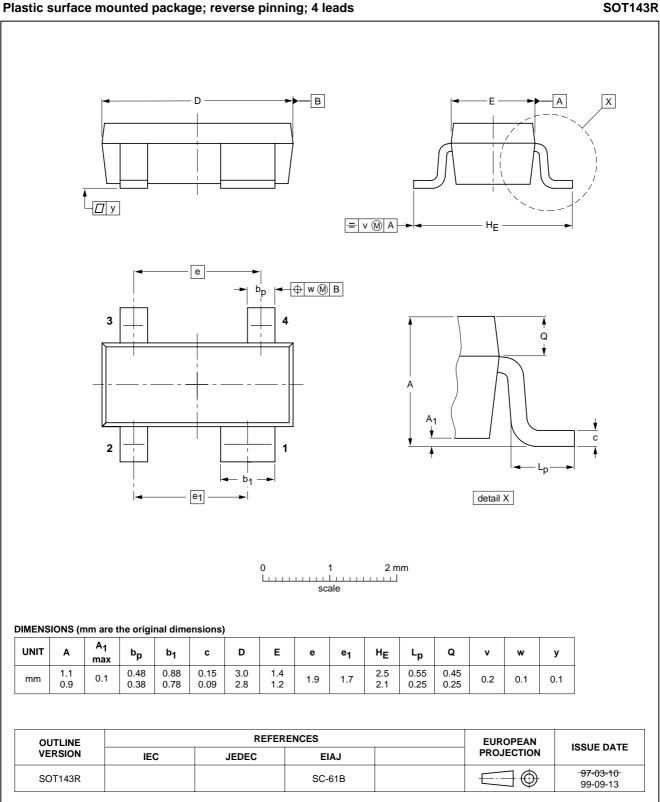
NPN 9 GHz wideband transistor

PACKAGE OUTLINES





BFG540; BFG540/X; BFG540/XR



SOT143R

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Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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Revision history

Revision history				
Document ID	Release date	Data sheet status	Change notice	Supersedes
BFG540_X_XR_N_5	20071121	Product data sheet	-	BFG540_X_XR_4
Modifications:	 Pinning tab 	le on page 2; changed code		
BFG540_X_XR_4 (9397 750 07059)	20000523	Product specification	-	BFG540XR_3
BFG540XR_3 (9397 750 03144)	19950901	Product specification	-	BFG540XR_2
BFG540XR_2	-	Product specification	-	BFG540XR_1
BFG540XR_1	-	-	-	-

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